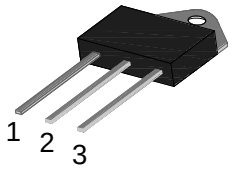
JST26Z 25A TRIACs

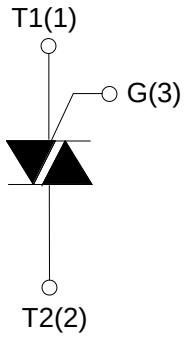
Rev.1.0

DESCRIPTION:

JST26Z provide high dv/dt rate with strong resistance to electromagnetic interface. With high commutation performances, 3 quadrants products especially recommended for use on inductive load.
JST26Z provide insulation voltage rated at 2500V RMS from all three terminals to external heatsink complying with UL standards (File ref: E252906).



TO-3P Insulated



MAIN FEATURES

Symbol	Value	Unit
$I_{T(RMS)}$	25	A
V_{DRM} /V_{RRM}	600 and 800 and 1200	V

ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Value	Unit
Storage junction temperature range		T_{stg}	-40-150	℃
Operating junction temperature range		T_j	-40-125	℃
Repetitive peak off-state voltage (T_j=25℃)		V_{DRM}	600/800/1200	V
Repetitive peak reverse voltage (T_j=25℃)		V_{RRM}	600/800/1200	V
Non repetitive surge peak Off-state voltage		V_{DSM}	V_{DRM} +100	V
Non repetitive peak reverse voltage		V_{RSM}	V_{RRM} +100	V
RMS on-state current	TO-3P(Ins) (T_C=100℃)	$I_{T(RMS)}$	25	A
Non repetitive surge peak on-state current (full cycle, F=50Hz)		I_{TSM}	250	A
I^2t value for fusing (tp=10ms)		I^2t	340	A^2s
Critical rate of rise of on-state current (I_G=2×I_{GT})		dI/dt	50	A/μs
Peak gate current		I_{GM}	4	A
Average gate power dissipation		$P_{G(AV)}$	1	W

Peak gate power	P_{GM}	10	W

ELECTRICAL CHARACTERISTICS (T_j=25℃ unless otherwise specified)

V_{DRM} /V_{RRM}: 600/800V

Symbol	Test Condition	Quadrant		JST26Z-600/800V		Unit
				BW	CW	
I_{GT}	V_D=12V R_L=33Ω	Ⅰ-Ⅱ-Ⅲ	MAX	50	35	mA
V_{GT}		Ⅰ-Ⅱ-Ⅲ	MAX	1.3		V
V_{GD}	V_D=V_{DRM} T_j=125℃ R_L=3.3KΩ	Ⅰ-Ⅱ-Ⅲ	MIN	0.2		V
I_L	I_G=1.2I_{GT}	Ⅰ-Ⅲ	MAX	80	70	mA
		Ⅱ		100	80	
I_H	I_T=100mA		MAX	75	50	mA
dV/dt	V_D=2/3V_{DRM} Gate Open T_j=125℃		MIN	1000	500	V/μs

V_{DRM} /V_{RRM}: 1200V

Symbol	Test Condition	Quadrant		JST26Z-1200V		Unit
				BW	CW	
I_{GT}	V_D =12V R_L=33Ω	Ⅰ-Ⅱ-Ⅲ	MAX	50	35	mA
V_{GT}		Ⅰ-Ⅱ-Ⅲ	MAX	1.5		V
V_{GD}	V_D =V_{DRM} T_j =125℃ R_L =3.3KΩ	Ⅰ-Ⅱ-Ⅲ	MIN	0.2		V
I_L	I_G =1.2I_{GT}	Ⅰ-Ⅲ	MAX	90	70	mA
		Ⅱ		100	80	
I_H	I_T =100mA		MAX	80	60	mA
dV/dt	V_D=2/3V_{DRM} Gate Open T_j=125℃		MIN	1500	1000	V/μs

STATIC CHARACTERISTICS

Symbol	Parameter		Value(MAX)	Unit
V_{TM}	I_{TM} =35A tp=380μs	T_j=25℃	1.5	V
I_{DRM}	V_D =V_{DRM} V_R =V_{RRM}	T_j=25℃	5	μA
I_{RRM}		T_j=125℃	3	mA

THERMAL RESISTANCES

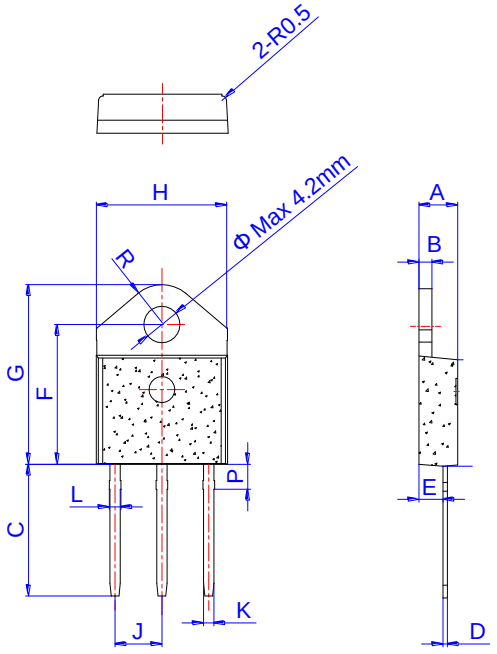
Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	junction to case(AC)	TO-3P(Ins)	0.8	℃/W

ORDERING INFORMATION

J ST 26 Z -600 BW

- J: JieJie Microelectronics Co.,Ltd
- ST: Triacs
- 26: $I_{T(RMS)}$:25A
- Z: TO-3P(Ins)
- -600: 600:V_{DRM} /V_{RRM}≥600V; 800:V_{DRM} /V_{RRM}≥800V; 1200:V_{DRM} /V_{RRM}≥1200V
- BW: BW:I_{GT3}≤50mA; CW:I_{GT3}≤35mA

PACKAGE MECHANICAL DATA



TO-3P Ins

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.40		4.60	0.173		0.181
B	1.45		1.55	0.057		0.061
C	14.35		15.60	0.565		0.614
D	0.50		0.70	0.020		0.028
E	2.70		2.90	0.106		0.114
F	15.80		16.50	0.622		0.650
G	20.40		21.10	0.803		0.831
H	15.10		15.50	0.594		0.610
J	5.40		5.65	0.213		0.222
K	1.10		1.40	0.043		0.055
L	1.35		1.50	0.053		0.059
P	2.80		3.00	0.110		0.118
R		4.35			0.171	

FIG.1: Maximum power dissipation versus RMS on-state current

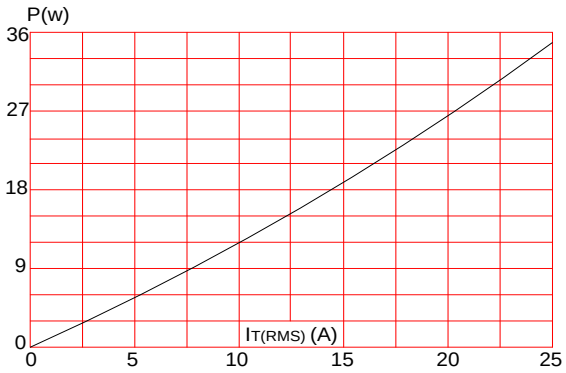


FIG.2: RMS on-state current versus case temperature

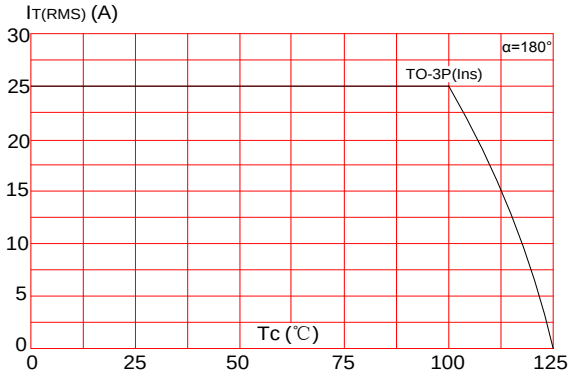


FIG.3: Surge peak on-state current versus number of cycles

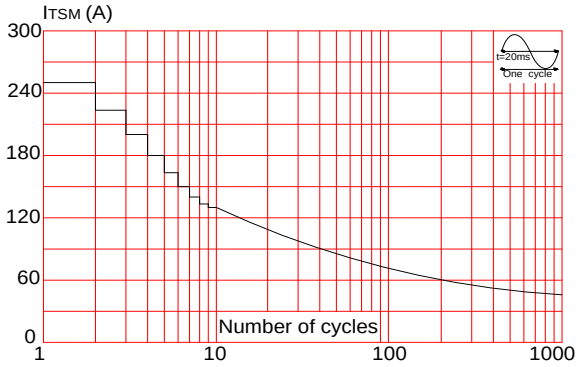


FIG.4: On-state characteristics (maximum values)

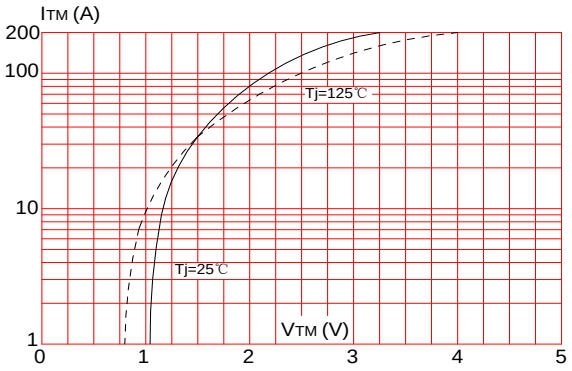


FIG.5: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp<10ms, and corresponging value of I^2t (dI/dt < 50A/μs)

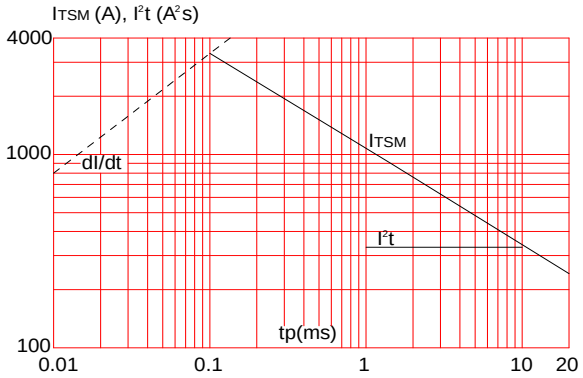
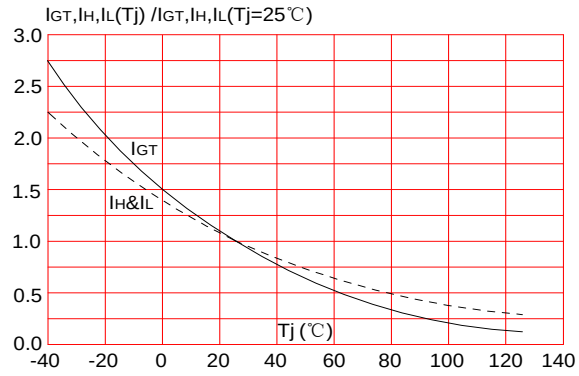


FIG.6: Relative variations of gate trigger current, holding current and latching current versus junction temperature



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